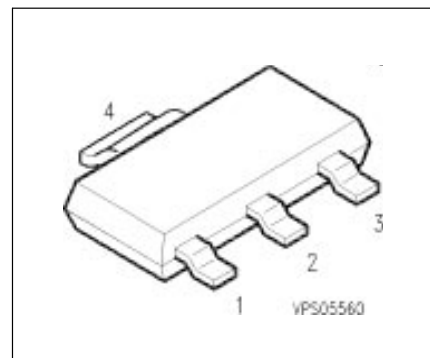


SIPMOS® Small-Signal Transistor

- N channel
- Enhancement mode
- Logic Level
- $V_{GS(th)} = 0.8...2.0V$



| | | | |
|-------|-------|-------|-------|
| Pin 1 | Pin 2 | Pin 3 | Pin 4 |
| G | D | S | D |

| Type | V_{DS} | I_D | $R_{DS(on)}$ | Package | Marking |
|---------|---------------|-------|---------------------------|---------|---------|
| BSP 295 | 50 V | 1.8 A | 0.3 Ω | SOT-223 | BSP 295 |
| Type | Ordering Code | | Tape and Reel Information | | |
| BSP 295 | Q67000-S066 | | E6327 | | |

Maximum Ratings

| Parameter | Symbol | Values | Unit |
|-------------------------------------|-------------|----------|------|
| Drain source voltage | V_{DS} | 50 | V |
| Drain-gate voltage | V_{DGR} | 50 | |
| $R_{GS} = 20 \text{ k}\Omega$ | | | |
| Gate source voltage | V_{GS} | ± 14 | |
| Gate-source peak voltage, aperiodic | V_{gs} | ± 20 | |
| Continuous drain current | I_D | 1.8 | A |
| $T_A = 34 \text{ }^\circ\text{C}$ | | | |
| DC drain current, pulsed | I_{Dpuls} | 7.2 | |
| $T_A = 25 \text{ }^\circ\text{C}$ | | | |
| Power dissipation | P_{tot} | 1.8 | W |
| $T_A = 25 \text{ }^\circ\text{C}$ | | | |

Maximum Ratings

| Parameter | Symbol | Values | Unit |
|--|------------|---------------|------|
| Chip or operating temperature | T_j | -55 ... + 150 | °C |
| Storage temperature | T_{stg} | -55 ... + 150 | |
| Thermal resistance, chip to ambient air | R_{thJA} | ≤ 70 | K/W |
| Thermal resistance, junction-soldering point ¹⁾ | R_{thJS} | ≤ 10 | |
| DIN humidity category, DIN 40 040 | | E | |
| IEC climatic category, DIN IEC 68-1 | | 55 / 150 / 56 | |

1) Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm² copper area for drain connection

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

Static Characteristics

| | | | | | |
|--|---------------|-----|------|-----|----|
| Drain- source breakdown voltage $V_{GS} = 0\text{ V}$, $I_D = 0.25\text{ mA}$, $T_j = 25^\circ\text{C}$ | $V_{(BR)DSS}$ | 50 | - | - | V |
| Gate threshold voltage $V_{GS} = V_{DS}$, $I_D = 1\text{ mA}$ | $V_{GS(th)}$ | 0.8 | 1.4 | 2 | |
| Zero gate voltage drain current $V_{DS} = 50\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 25^\circ\text{C}$ | I_{DSS} | - | 0.1 | 1 | μA |
| $V_{DS} = 50\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 125^\circ\text{C}$ | | - | 8 | 50 | |
| $V_{DS} = 30\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 25^\circ\text{C}$ | | - | - | 100 | nA |
| Gate-source leakage current $V_{GS} = 20\text{ V}$, $V_{DS} = 0\text{ V}$ | I_{GSS} | - | 10 | 100 | nA |
| Drain-Source on-state resistance $V_{GS} = 10\text{ V}$, $I_D = 1.8\text{ A}$ | $R_{DS(on)}$ | - | 0.25 | 0.3 | Ω |
| $V_{GS} = 4.5\text{ V}$, $I_D = 1.8\text{ A}$ | | - | 0.45 | 0.5 | |

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

Dynamic Characteristics

| | | | | | |
|---|--------------|-----|-----|-----|----|
| Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}, I_D = 1.7 \text{ A}$ | g_{fs} | 0.5 | 1.7 | - | S |
| Input capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | C_{iss} | - | 320 | 425 | pF |
| Output capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | C_{oss} | - | 110 | 170 | |
| Reverse transfer capacitance $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | C_{rss} | - | 50 | 75 | |
| Turn-on delay time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 0.29 \text{ A}$ $R_{GS} = 50 \Omega$ | $t_{d(on)}$ | - | 8 | 12 | ns |
| Rise time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 0.29 \text{ A}$ $R_{GS} = 50 \Omega$ | t_r | - | 20 | 30 | |
| Turn-off delay time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 0.29 \text{ A}$ $R_{GS} = 50 \Omega$ | $t_{d(off)}$ | - | 120 | 160 | |
| Fall time $V_{DD} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 0.29 \text{ A}$ $R_{GS} = 50 \Omega$ | t_f | - | 85 | 115 | |

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

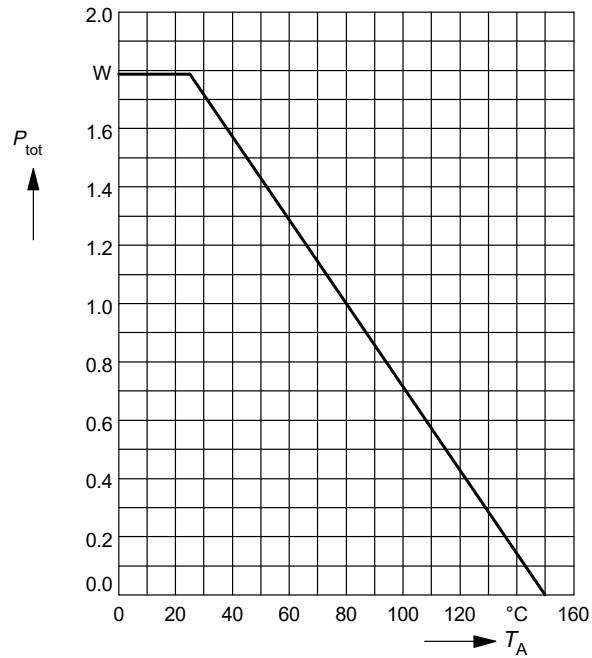
| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

Reverse Diode

| | | | | | |
|--|----------|---|-----|-----|---|
| Inverse diode continuous forward current $T_A = 25^\circ\text{C}$ | I_S | - | - | 1.8 | A |
| Inverse diode direct current, pulsed $T_A = 25^\circ\text{C}$ | I_{SM} | - | - | 7.2 | |
| Inverse diode forward voltage $V_{GS} = 0\text{ V}, I_F = 3.6\text{ A}, T_j = 25^\circ\text{C}$ | V_{SD} | - | 1.1 | 1.5 | V |

Power dissipation

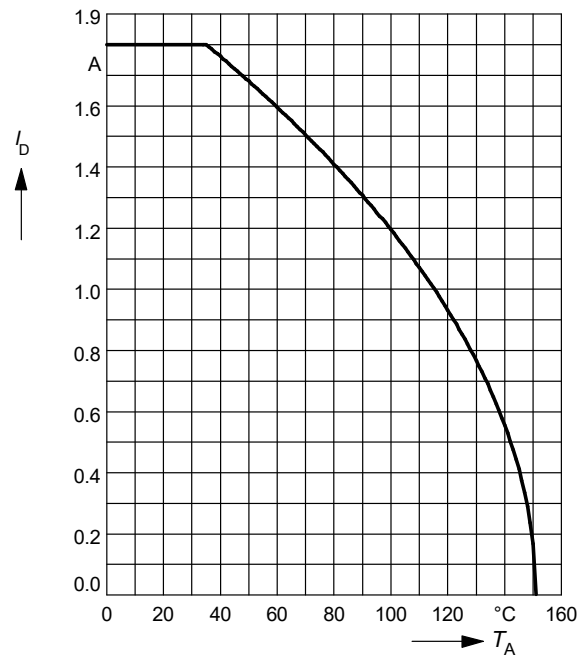
$$P_{\text{tot}} = f(T_A)$$



Drain current

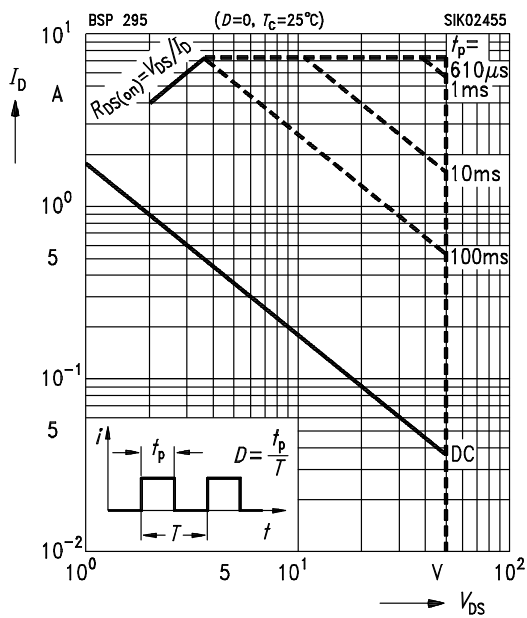
$$I_D = f(T_A)$$

parameter: $V_{GS} \geq 10 \text{ V}$



Safe operating area $I_D = f(V_{DS})$

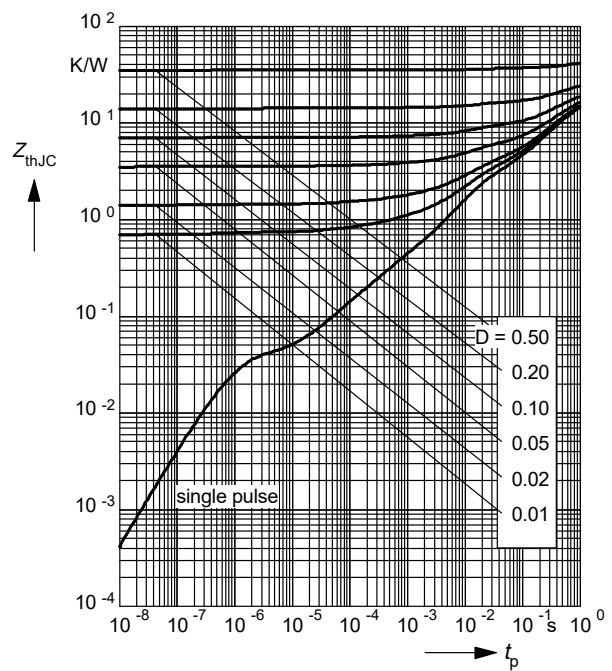
parameter: $D = 0$, $T_C = 25^\circ\text{C}$



Transient thermal impedance

$$Z_{\text{thJA}} = f(t_p)$$

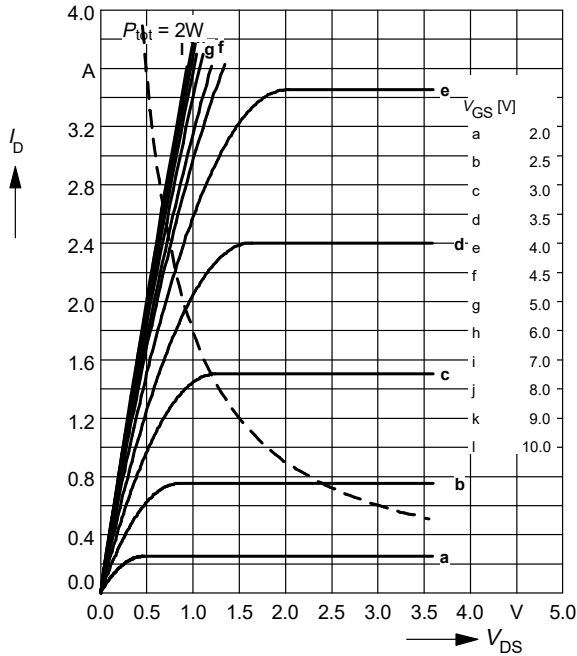
parameter: $D = t_p / T$



Typ. output characteristics

$$I_D = f(V_{DS})$$

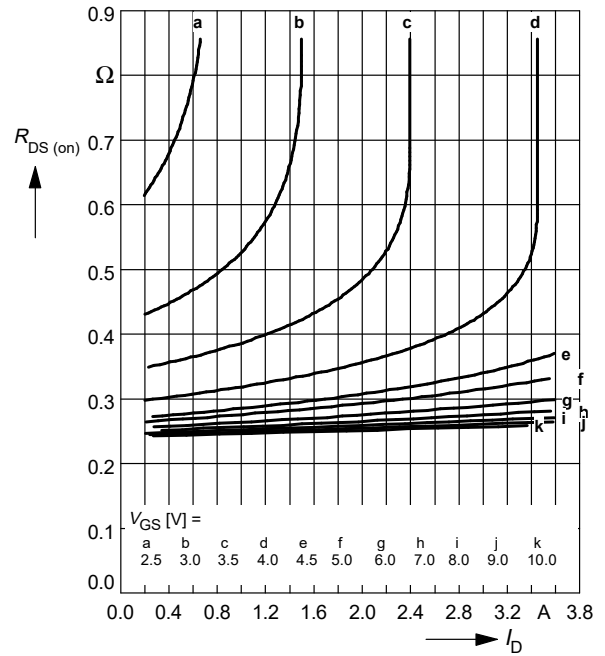
parameter: $t_p = 80 \mu s$, $T_j = 25^\circ C$



Typ. drain-source on-resistance

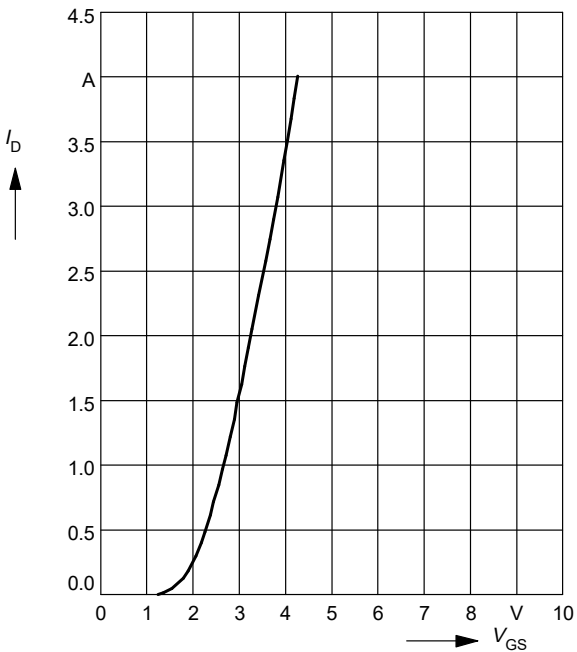
$$R_{DS(on)} = f(I_D)$$

parameter: $t_p = 80 \mu s$, $T_j = 25^\circ C$



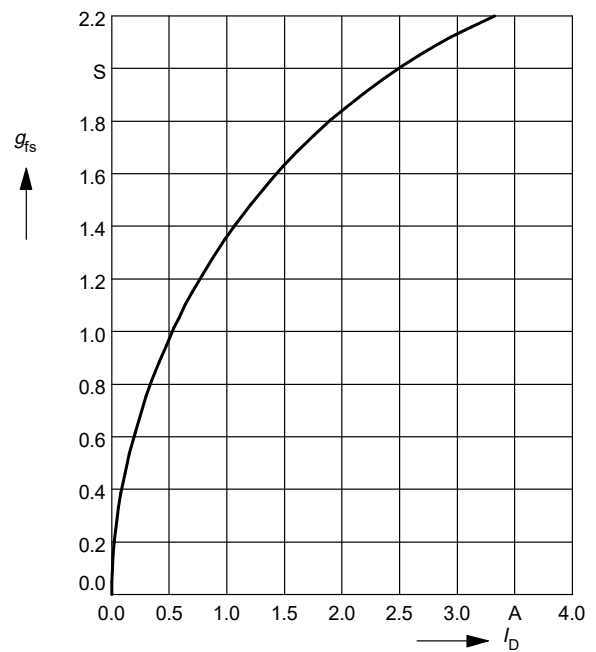
Typ. transfer characteristics $I_D = f(V_{GS})$

parameter: $t_p = 80 \mu s$



Typ. forward transconductance $g_{fs} = f(I_D)$

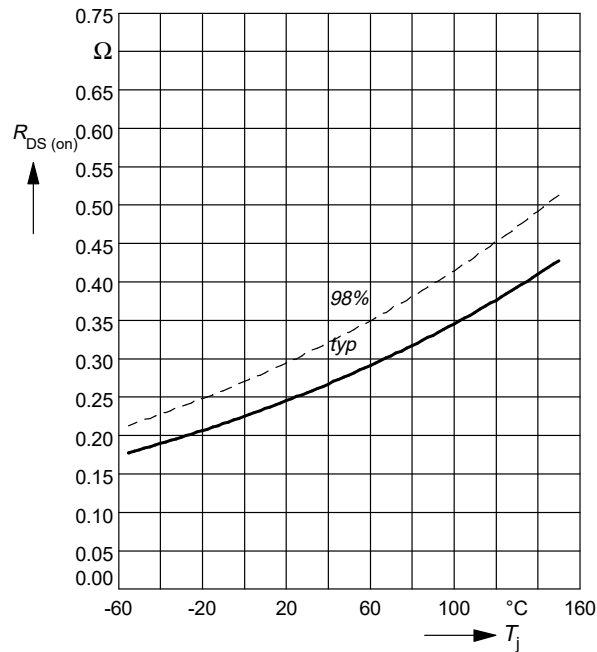
parameter: $t_p = 80 \mu s$,



Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

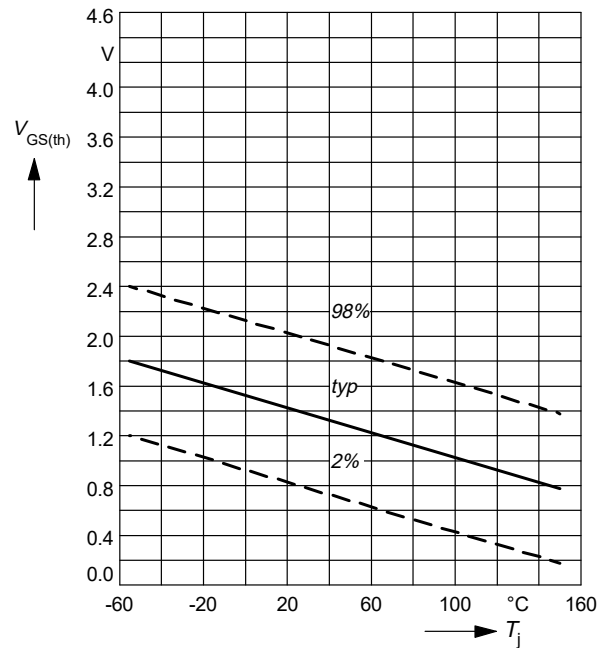
parameter: $I_D = 1.8 \text{ A}$, $V_{GS} = 10 \text{ V}$



Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

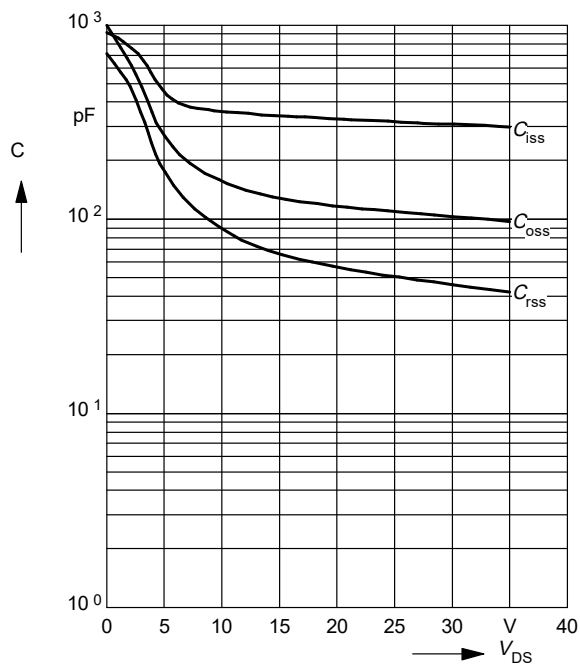
parameter: $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$



Typ. capacitances

$$C = f(V_{DS})$$

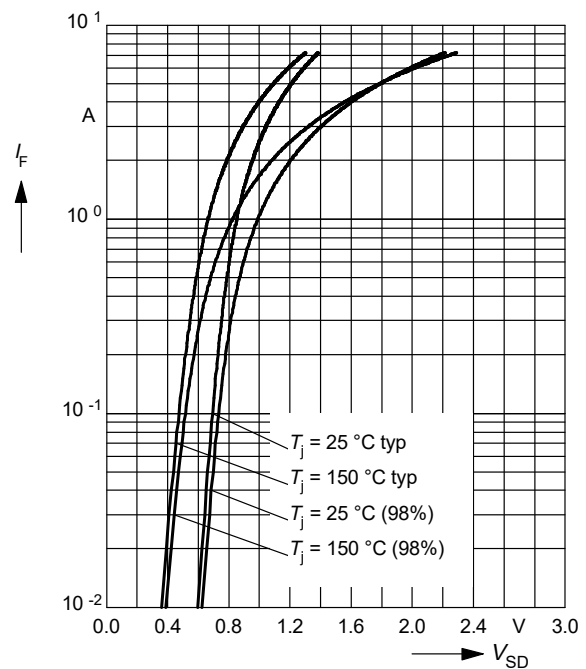
parameter: $V_{GS}=0\text{V}$, $f = 1 \text{ MHz}$



Forward characteristics of reverse diode

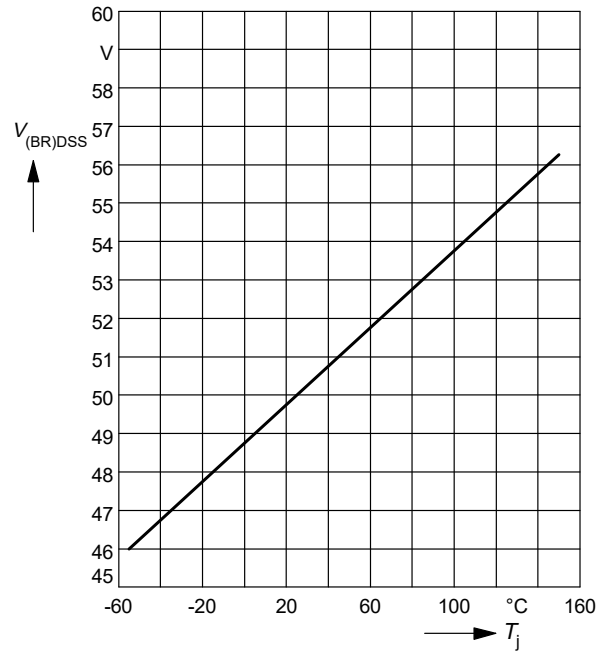
$$I_F = f(V_{SD})$$

parameter: $T_j, t_p = 80 \mu\text{s}$



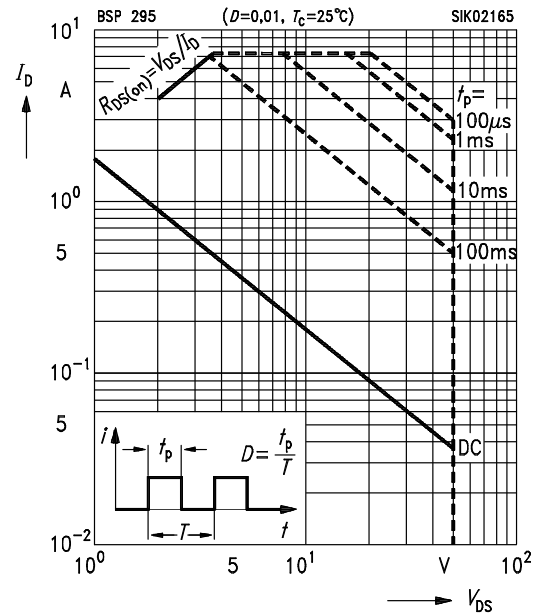
Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$



Safe operating area $I_D = f(V_{DS})$

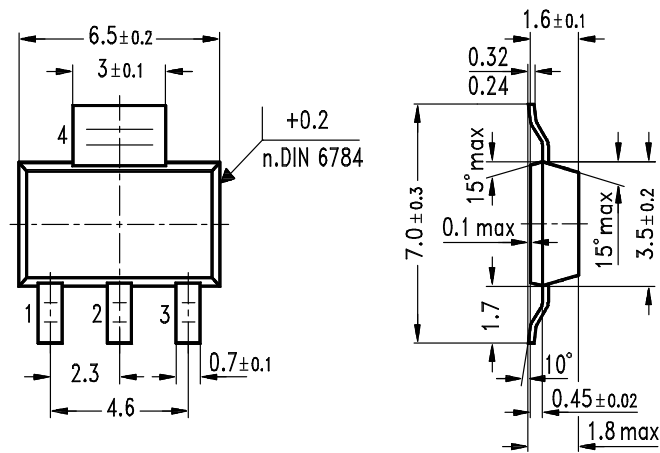
parameter : $D = 0.01$, $T_C = 25^\circ\text{C}$



Package outlines

SOT-223

Dimensions in mm



GPS05560